150mA 10V INPUT LDO REGULATOR

No. EA-245-200219

OUTLINE

The RP171x is LDO regulator featuring 150mA output current. Because of the 10V maximum input voltage, RP171x can be used in 2 cell lithium-ion battery powered portable appliances and besides a portable equipment. The supply current is Typ. 23μA though an excellent response characteristics.
The output voltage range from 1.2V is possible. The output voltage accuracy and temperature-drift coefficient of output voltage of the RP171x Series are excellent.
RP171x has a fold-back protection circuit and a thermal shutdown circuit. Moreover, a standby mode with ultra-low supply current can be realized with the chip enable function.
SC-88A and SOT-23-5 with high power dissipation packages are available.

FEATURES

- Supply Current ····· Typ. 23μA
- Standby Mode ····· Typ. 0.1μA
- Dropout Voltage ····· Typ. 0.20V (I_{OUT}=100mA, V_{OUT}=3.0V)
  Typ. 0.40V (I_{OUT}=150mA, V_{OUT}=2.8V)
- Ripple Rejection ····· Typ. 70dB (f=1kHz)
- Temperature-Drift Coefficient of Output Voltage ····· Typ. ±80ppm/°C
- Line Regulation ····· Typ. 0.02%/V
- Output Voltage Accuracy ····· ±1.0%
- Packages ····· SC-88A, SOT-23-5
- Input Voltage Range ····· 2.6V to 10.0V
- Output Voltage Range ····· 1.2V to 6.5V (0.1V steps)
  (For other voltages, please refer to MARK INFORMATIONS.)
- Built-in Fold Back Protection Circuit ····· Typ. 40mA (Current at short mode)
- Built-in Thermal Shutdown Circuit ····· Shutdown Temperature at 165°C
- Built-in Constant Slope Circuit (Soft-start Function)
- Ceramic capacitors are recommended to be used with this IC ····· 1.0μF or more

APPLICATIONS

- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for battery-powered equipment.
- Power source for home appliances.

SELECTION GUIDE

The output voltage, auto-discharge(1) function, and package, etc. for the ICs can be selected at the user's request.

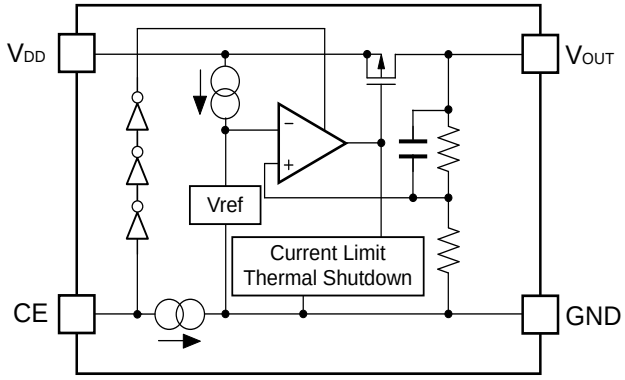
Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP171Qxx2∗-TR-FE	SC-88A	3,000 pcs	Yes	Yes
RP171Nxx1∗-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

xx: The output voltage can be designated in the range from 1.2V(12) to 6.5V(65) in 0.1V steps.
The voltage in 0.05 V step is shown as follows.
Example. 1.25 V: RP171x12x∗5

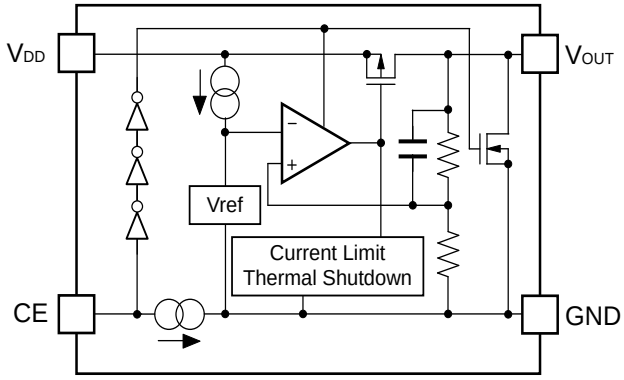
∗ : The auto discharge function at off state are options as follows.
(B) without auto discharge function at off state
(D) with auto discharge function at off state

BLOCK DIAGRAMS

RP171xxxxB



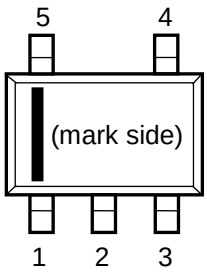
RP171xxxxD



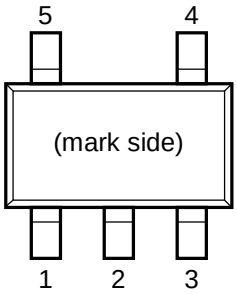
(1) Auto-discharge function quickly lowers the output voltage to 0V by releasing the electrical charge accumulated in the external capacitor when the chip enable signal is switched from the active mode to the standby mode.

PIN CONFIGURATIONS

● **SC-88A**



● **SOT-23-5**



PIN DESCRIPTIONS

● **SC-88A**

Pin No.	Symbol	Pin Description
1	CE	Chip Enable Pin ("H" Active)
2 *	NC	No Connection
3	GND	Ground Pin
4	VOUT	Output Pin
5	VDD	Input Pin

∗ Pin No. 2 is connected to the bottom of the IC. It is recommended that the pin be connected to the ground plane on the board, or otherwise be left floating so that there is no contact with other potentials.

● **SOT-23-5**

Pin No	Symbol	Pin Description
1	VDD	Input Pin
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	NC	No Connection
5	VOUT	Output Pin

ABSOLUTE MAXIMUM RATINGS

Symbol	Item		Rating	Unit
V_{IN}	Input Voltage		12	V
V_{CE}	Input Voltage (CE Pin)		12	V
V_{OUT}	Output Voltage		−0.3 to V_{IN}+0.3	V
I_{OUT}	Output Current		330	mA
P_D	Power Dissipation (1)	SC-88A (Our Standard Test Land Pattern)	380	mW
		SOT-23-5 (JEDEC STD. 51-7)	660	
Tj	Junction Temperature Range		−40 to 125	°C
Tstg	Storage Temperature Range		−55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECCOMENDED OPERATING CONDITIONS

Symbol	Parameter	Rating	Unit
V_{IN}	Input Voltage	2.6 to 10	V
Ta	Operating Temperature Range	−40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such ratings by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

(1) Refer to POWER DISSIPATION for detailed information

ELECTRICAL CHARACTERISTICS

V_{IN}=Set V_{OUT}+1V, I_{OUT}=1mA, unless otherwise noted.
The specifications in [ ] are guaranteed by Design Engineering at - 40ºC ≤ Ta ≤ 85ºC.

RP171xxxxB/D (Ta = 25°C)

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
V_{OUT}	Output Voltage	Ta=25°C	V_{OUT} > 1.5V	×0.99		×1.01	V
			V_{OUT} ≤ 1.5V	−15		+15	mV
		−40°C ≤ Ta ≤ 85°C	V_{OUT} > 1.5V	[×0.974]		[×1.023]	V
			V_{OUT} ≤ 1.5V	[−40]		[+35]	mV
I_{OUT}	Output Current			[150]			mA
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	0.1mA ≤ I_{OUT} ≤ 150mA			5	[40]	mV
V_{DIF}	Dropout Voltage	I_{OUT}=150mA	1.2V ≤ V_{OUT} < 1.3V		-	[1.400]	V
			1.3V ≤ V_{OUT} < 1.5V		-	[1.300]	
			1.5V ≤ V_{OUT} < 1.8V		-	[1.100]	
			1.8V ≤ V_{OUT} < 2.3V		-	[0.800]	
			2.3V ≤ V_{OUT} < 3.0V		0.400	[0.580]	
			3.0V ≤ V_{OUT} < 4.0V		0.300	[0.480]	
			4.0V ≤ V_{OUT} ≤ 6.5V		0.250	[0.400]	
I_{SS}	Supply Current	I_{OUT}=0mA			23	[40]	μA
Istandby	Standby Current	V_{IN}=10.0V, V_{CE}=GND			0.1	1.0	μA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	Set V_{OUT}+0.5V ≤ V_{IN} ≤ 10.0V (In case that V_{OUT} ≤ 2.1V, 2.6V ≤ V_{IN} ≤ 10.0V)			±0.02	[±0.2]	%/V
RR	Ripple Rejection	f=1kHz, Ripple 0.2Vp-p, I_{OUT}=30mA (In case that V_{OUT} < 2.0V, V_{IN}=3.0V)			70		dB
I_{SC}	Short Current Limit	V_{OUT}=0V			40		mA
I_{PD}	CE Pull-down Current				0.30		μA
V_{CEH}	CE Input Voltage "H"			[1.7]			V
V_{CEL}	CE Input Voltage "L"					[0.8]	V
T_{TSD}	Thermal Shutdown Temperature	Junction Temperature			165		°C
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature			110		°C
en	Output Noise	BW=10Hz to 100kHz			100		μVrms
R_{LOW}	Low Output Nch Tr. ON Resistance (of D version)	V_{IN}=7.0V V_{CE}=0V			250		Ω

All of unit are tested and specified under load conditions such that Tj≈Ta=25°C except for Output Noise, Ripple Rejection and Thermal Shutdown.

Product-specific Electrical Characteristics

The specifications surrounded by ☐ are guaranteed by design engineering at –40°C ≤ Ta ≤ 85°C.

RP171xxxxB/D (Ta = 25°C)

Product Name	V_{OUT} [V] (Ta = 25°C)			V_{OUT} [V] (Ta = –40 to 85°C)			V_{DIF} [V]	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	TYP.	MAX.
RP171x12xx	1.185	1.2	1.215	1.160	1.2	1.235	1.400	1.800
RP171x12xx5	1.235	1.25	1.265	1.210	1.25	1.285		
RP171x13xx	1.285	1.3	1.315	1.260	1.3	1.335	1.350	1.750
RP171x14xx	1.385	1.4	1.415	1.360	1.4	1.435		
RP171x15xx	1.485	1.5	1.515	1.460	1.5	1.535	1.200	1.550
RP171x16xx	1.584	1.6	1.616	1.558	1.6	1.637		
RP171x17xx	1.683	1.7	1.717	1.656	1.7	1.739		
RP171x18xx	1.782	1.8	1.818	1.753	1.8	1.841	0.980	1.300
RP171x18xx5	1.832	1.85	1.869	1.802	1.85	1.893		
RP171x19xx	1.881	1.9	1.919	1.851	1.9	1.944		
RP171x20xx	1.980	2.0	2.020	1.948	2.0	2.046		
RP171x21xx	2.079	2.1	2.121	2.045	2.1	2.148		
RP171x22xx	2.178	2.2	2.222	2.143	2.2	2.251		
RP171x23xx	2.277	2.3	2.323	2.240	2.3	2.353	0.770	1.080
RP171x24xx	2.376	2.4	2.424	2.338	2.4	2.455		
RP171x25xx	2.475	2.5	2.525	2.435	2.5	2.558		
RP171x26xx	2.574	2.6	2.626	2.532	2.6	2.660		
RP171x27xx	2.673	2.7	2.727	2.630	2.7	2.762		
RP171x28xx	2.772	2.8	2.828	2.727	2.8	2.864		
RP171x28xx5	2.822	2.85	2.879	2.776	2.85	2.916		
RP171x29xx	2.871	2.9	2.929	2.825	2.9	2.967		
RP171x30xx	2.970	3.0	3.030	2.922	3.0	3.069	0.600	0.850
RP171x31xx	3.069	3.1	3.131	3.019	3.1	3.171		
RP171x32xx	3.168	3.2	3.232	3.117	3.2	3.274		
RP171x33xx	3.267	3.3	3.333	3.214	3.3	3.376		
RP171x34xx	3.366	3.4	3.434	3.312	3.4	3.478		
RP171x35xx	3.465	3.5	3.535	3.409	3.5	3.581		
RP171x36xx	3.564	3.6	3.636	3.506	3.6	3.683		
RP171x37xx	3.663	3.7	3.737	3.604	3.7	3.785		
RP171x38xx	3.762	3.8	3.838	3.701	3.8	3.887		
RP171x39xx	3.861	3.9	3.939	3.799	3.9	3.990		

Product-specific Electrical Characteristics

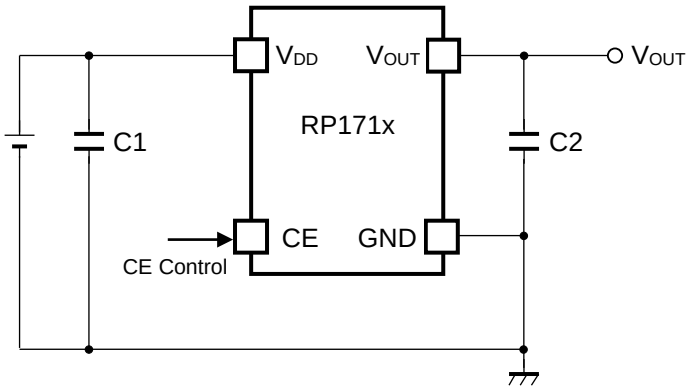
The specifications surrounded by ☐ are guaranteed by design engineering at –40°C ≤ Ta ≤ 85°C.

RP171xxxxB/D (Ta = 25°C)

Product Name	V_{OUT} [V] (Ta = 25°C)			V_{OUT} [V] (Ta = –40 to 85°C)			V_{DIF} [V]	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	TYP.	MAX.
RP171x40xx	3.960	4.0	4.040	3.896	4.0	4.092	0.500	0.750
RP171x41xx	4.059	4.1	4.141	3.993	4.1	4.194		
RP171x42xx	4.158	4.2	4.242	4.091	4.2	4.297		
RP171x43xx	4.257	4.3	4.343	4.188	4.3	4.399		
RP171x44xx	4.356	4.4	4.444	4.286	4.4	4.501		
RP171x45xx	4.455	4.5	4.545	4.383	4.5	4.604		
RP171x46xx	4.554	4.6	4.646	4.480	4.6	4.706		
RP171x47xx	4.653	4.7	4.747	4.578	4.7	4.808		
RP171x48xx	4.752	4.8	4.848	4.675	4.8	4.910		
RP171x49xx	4.851	4.9	4.949	4.773	4.9	5.013		
RP171x50xx	4.950	5.0	5.050	4.870	5.0	5.115		
RP171x51xx	5.049	5.1	5.151	4.967	5.1	5.217		
RP171x52xx	5.148	5.2	5.252	5.065	5.2	5.320		
RP171x53xx	5.247	5.3	5.353	5.162	5.3	5.422		
RP171x54xx	5.346	5.4	5.454	5.260	5.4	5.524		
RP171x55xx	5.445	5.5	5.555	5.357	5.5	5.627		
RP171x56xx	5.544	5.6	5.656	5.454	5.6	5.729		
RP171x57xx	5.643	5.7	5.757	5.552	5.7	5.831		
RP171x58xx	5.742	5.8	5.858	5.649	5.8	5.933		
RP171x59xx	5.841	5.9	5.959	5.747	5.9	6.036		
RP171x60xx	5.940	6.0	6.060	5.844	6.0	6.138		
RP171x61xx	6.039	6.1	6.161	5.941	6.1	6.240		
RP171x62xx	6.138	6.2	6.262	6.039	6.2	6.343		
RP171x63xx	6.237	6.3	6.363	6.136	6.3	6.445		
RP171x64xx	6.336	6.4	6.464	6.234	6.4	6.547		
RP171x65xx	6.435	6.5	6.565	6.331	6.5	6.650		

APPLICATION INFORMATION

TYPICAL APPLICATION



(External Components)
C2 1.0μF MURATA: GRM155B31A105KE15

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with 1.0μF or more and good ESR (Equivalent Series Resistance).

(Note: If additional ceramic capacitors are connected with parallel to the output pin with an output capacitor for phase compensation, the operation might be unstable. Because of this, test these ICs with as same external components as ones to be used on the PCB.)

PCB Layout

Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as 1.0μF or more between V_{DD} and GND pin, and as close as possible to the pins.

Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

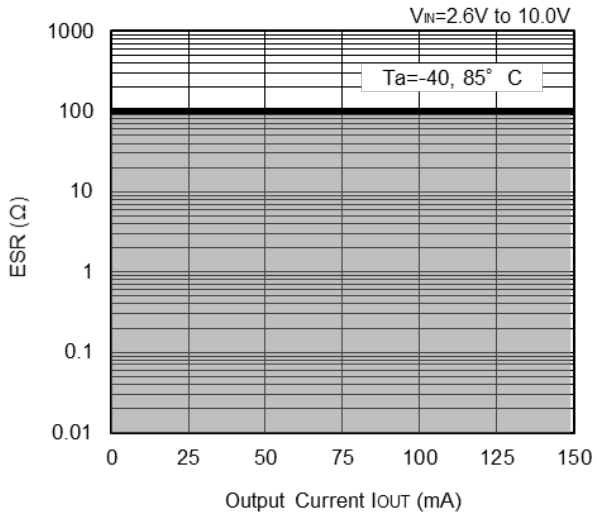
ESR vs. Output Current

When using these ICs, consider the following points:

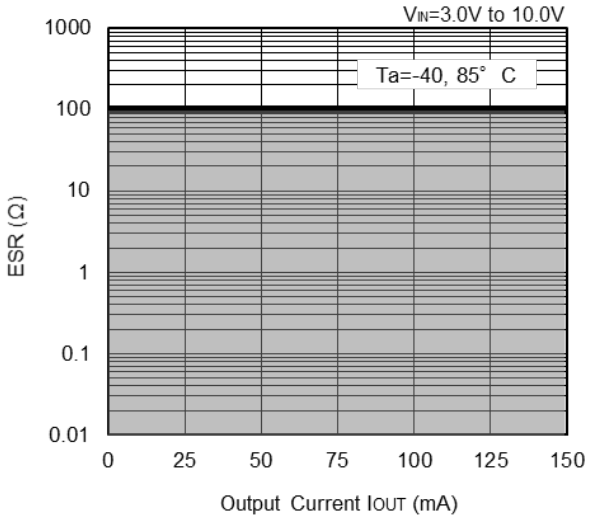
The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below.
The conditions when the white noise level is under 40μV (Avg.) are marked as the hatched area in the graph.

Measurement conditions
Frequency Band : 10Hz to 2MHz
Temperature : −40°C to 85°C
C1, C2 : Ceramic 1.0μF (Murata GRM155B31A105KE)

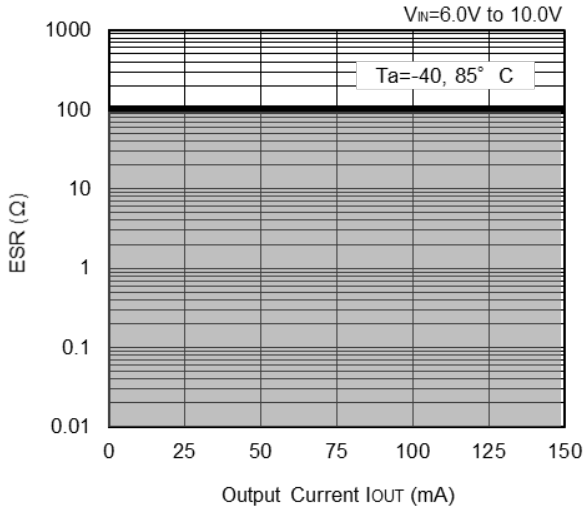
RP171x12xx



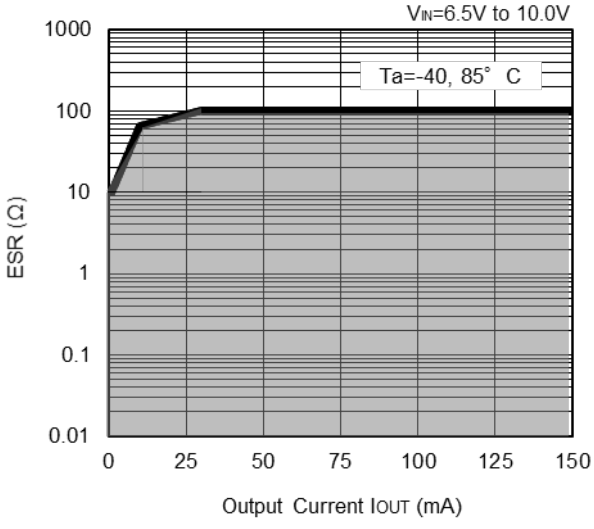
RP171x30xx



RP171x60xx



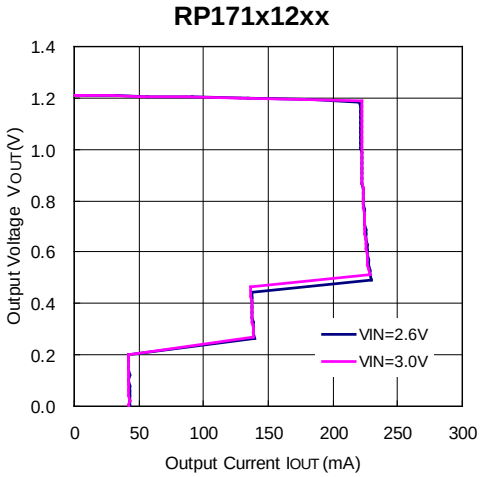
RP171x65xx

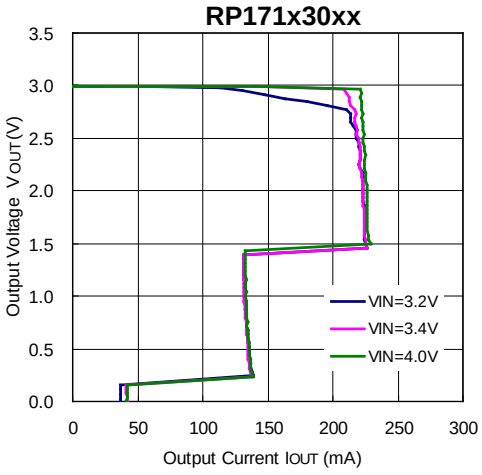


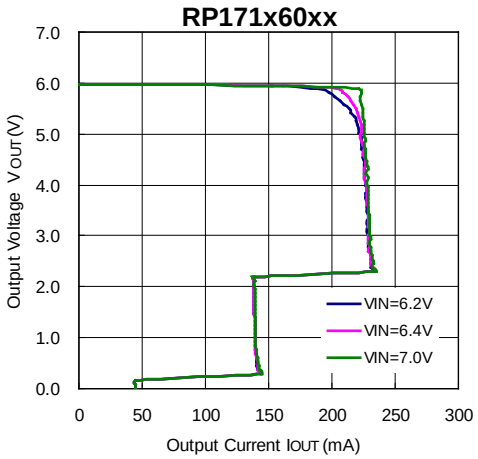
TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

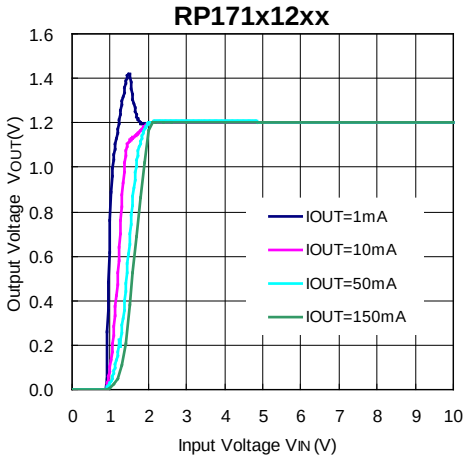
1) Output Voltage vs. Output Current (Ta = 25°C)

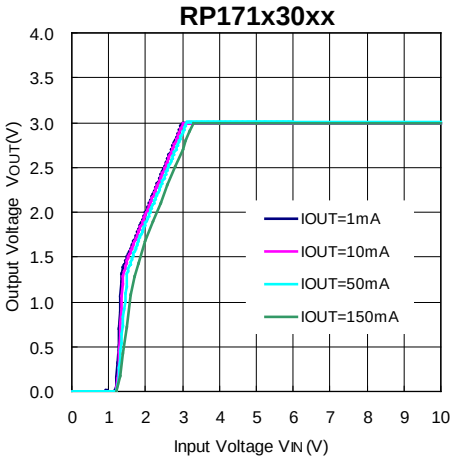




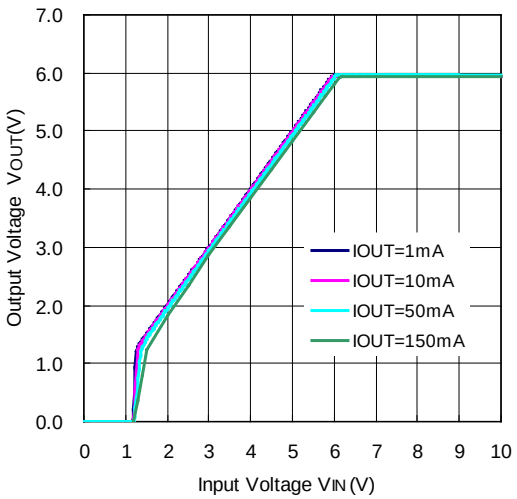


2) Output Voltage vs. Input Voltage (Ta = 25°C)



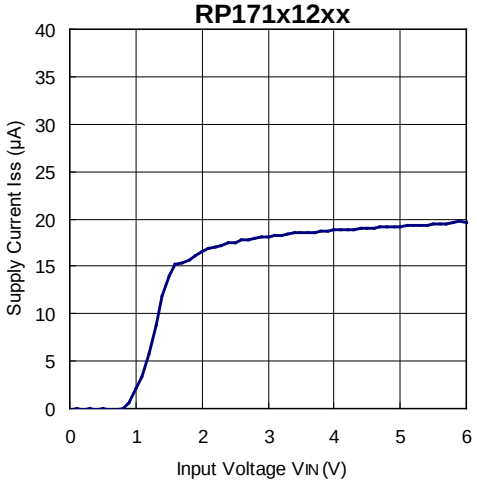


RP171x60xx

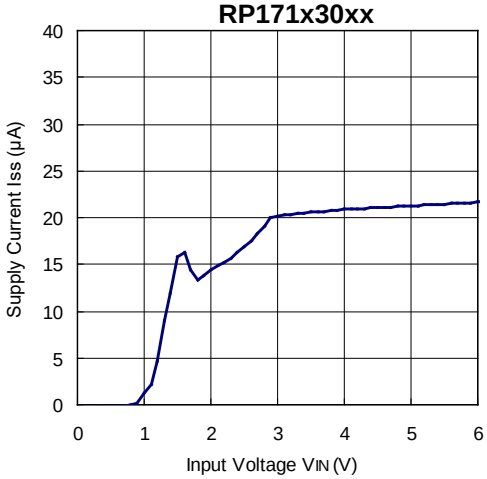


3) Supply Current vs. Input Voltage (Ta = 25°C)

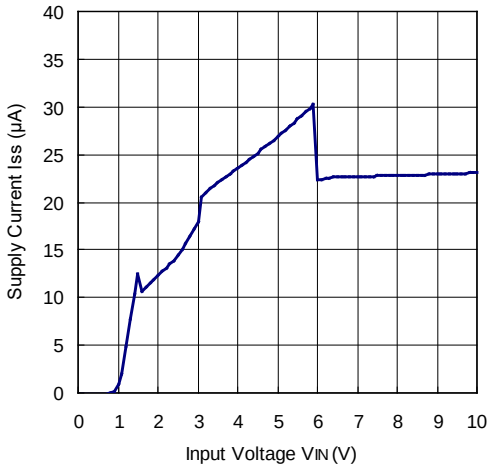
RP171x12xx



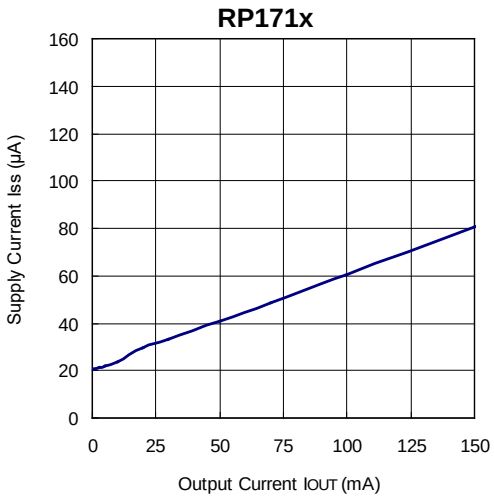
RP171x30xx



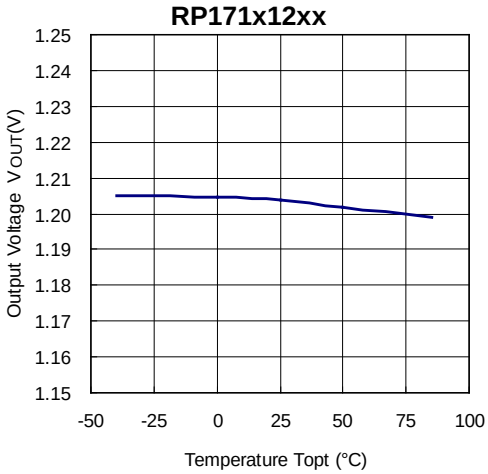
RP171x60xx

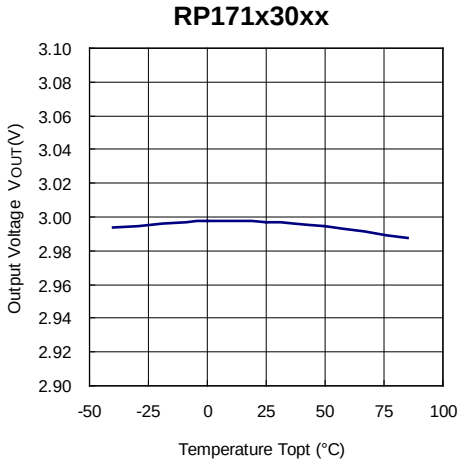


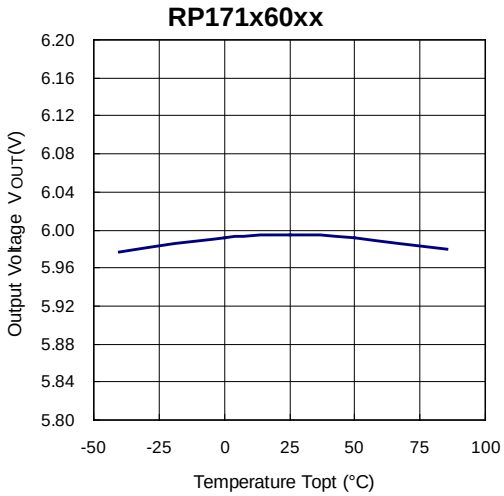
4) Supply Current vs. Output Current (Ta = 25°C)



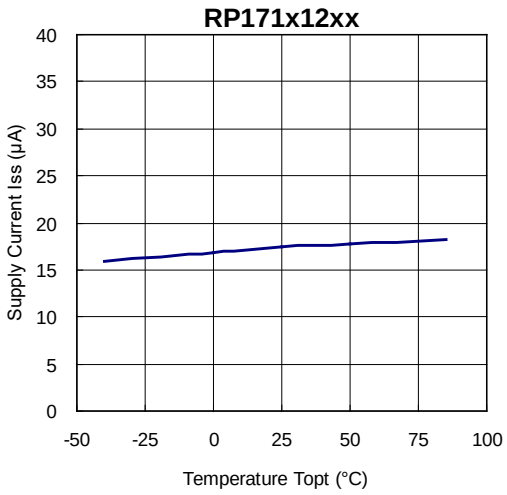
5) Output Voltage vs. Temperature

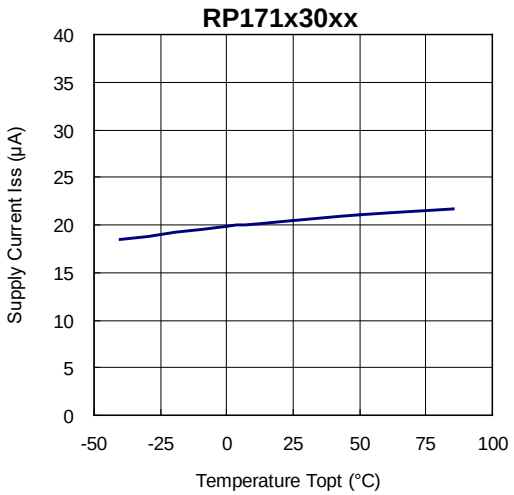


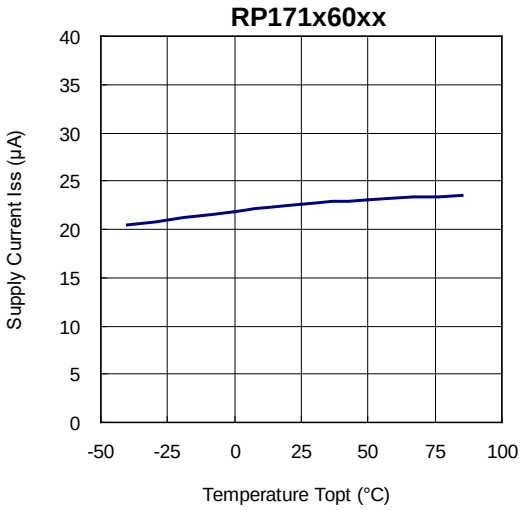




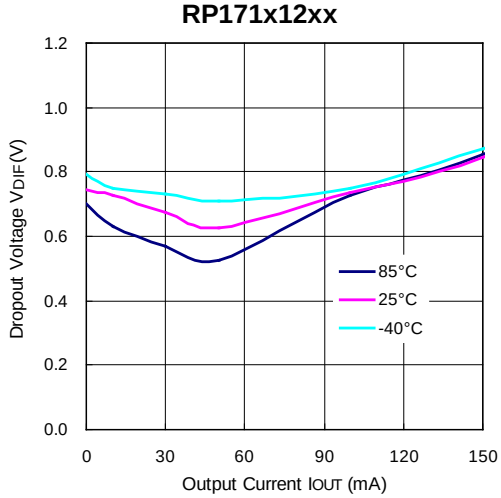
6) Supply Current vs. Temperature

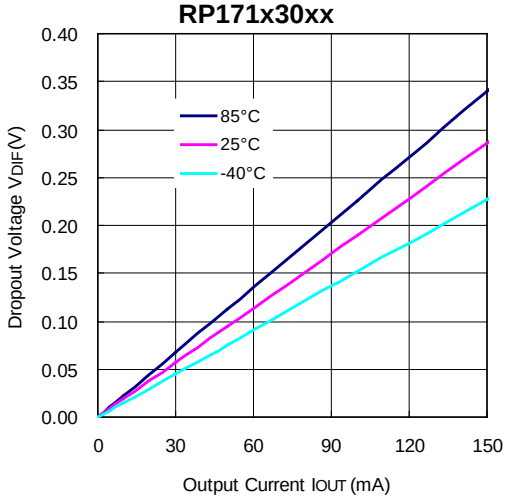




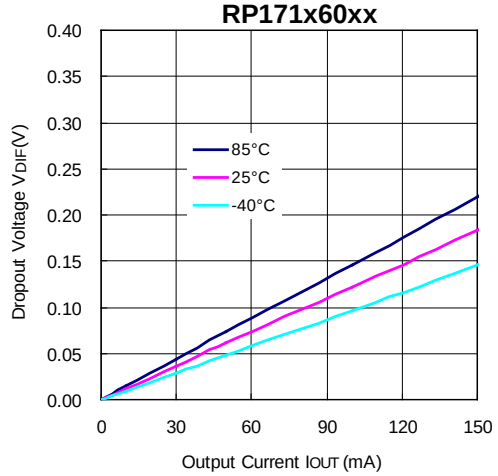


7) Dropout Voltage vs. Output Current



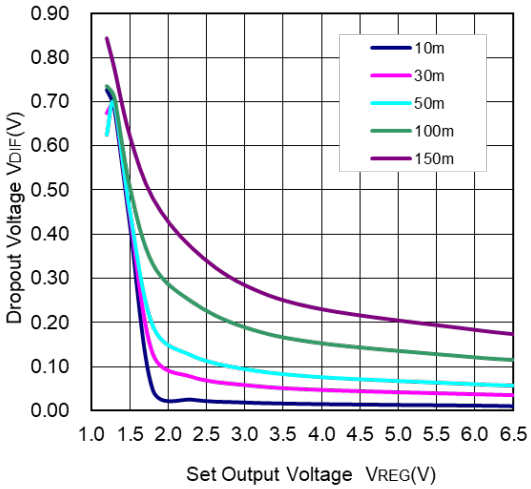


RP171x60xx



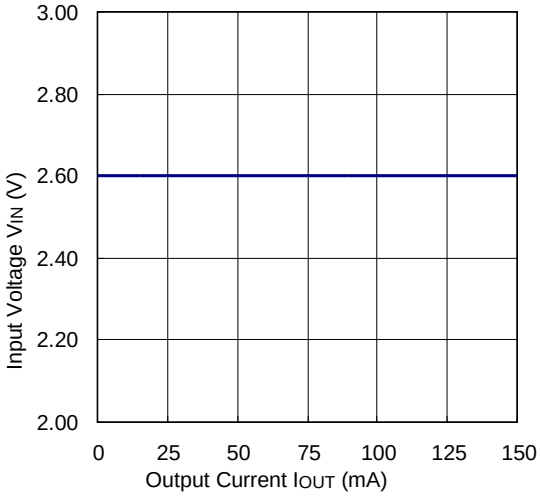
8) Dropout Voltage vs. Set Output Voltage (Ta = 25°C)

RP171x

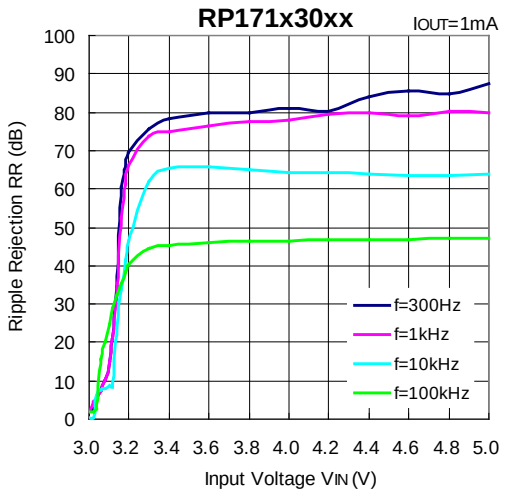


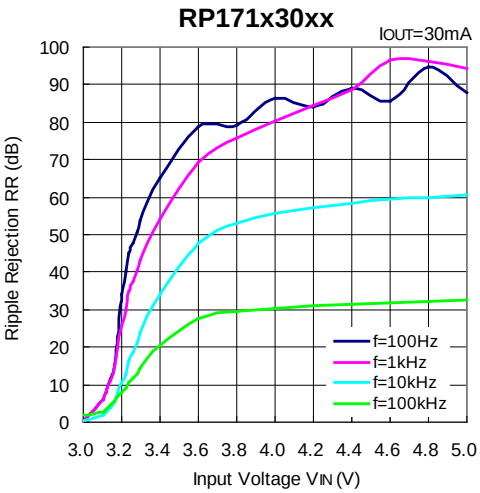
9) Minimum Operating Voltage

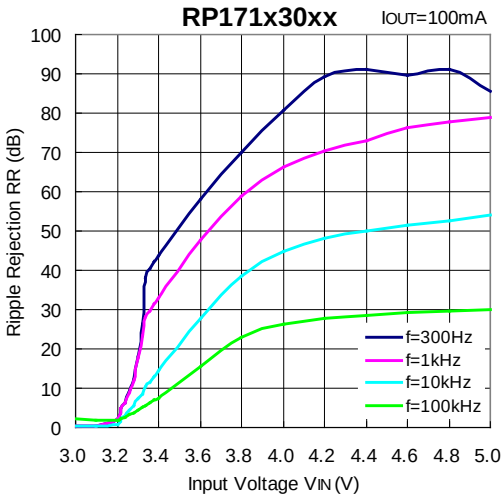
RP171x12xx



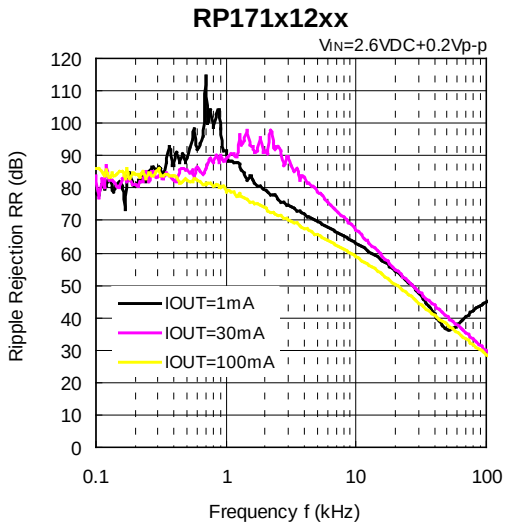
10) Ripple Rejection vs. Input Bias Voltage (C1=none, C2=Ceramic 1.0µF, Ripple=0.2Vp-p, Ta = 25°C)

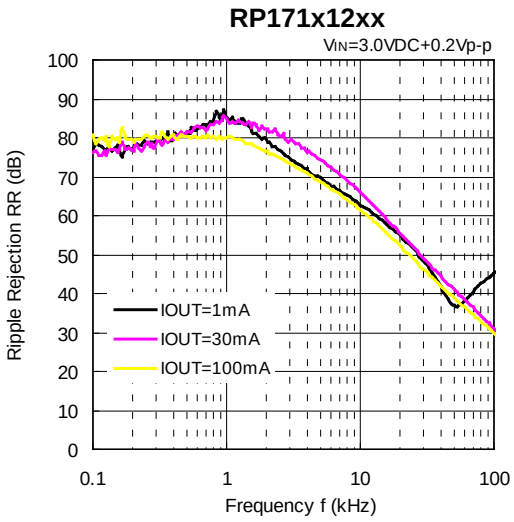




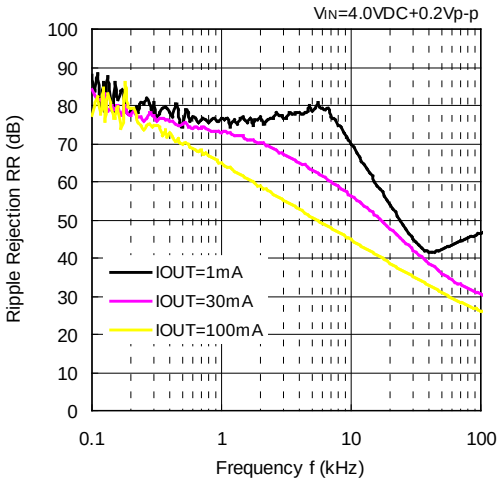


11) Ripple Rejection vs. Frequency (C1=none, C2=Ceramic 1.0µF, Ta=25°C)

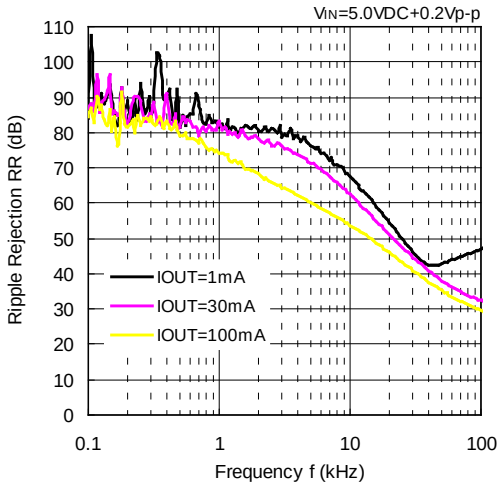




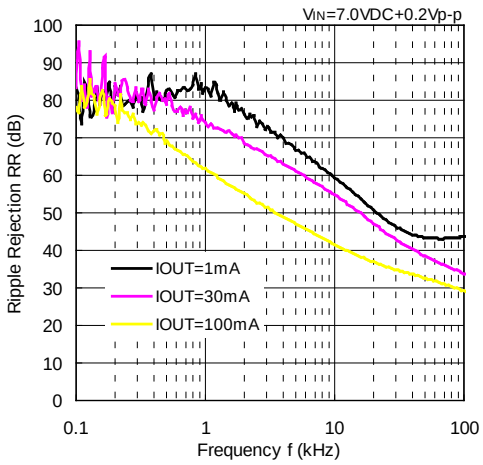
RP171x30xx



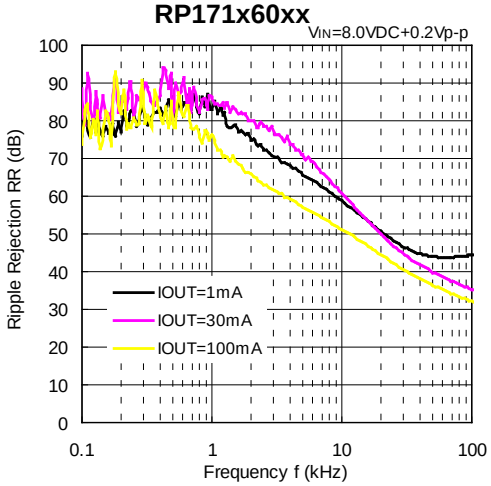
RP171x30xx



RP171x60xx

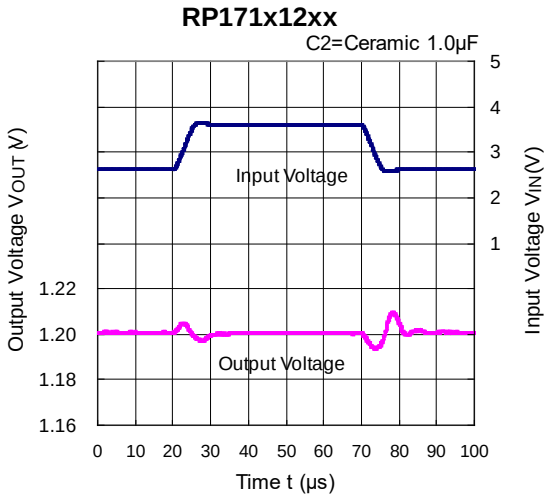


RP171x60xx



12) Input Transient Response (C1=none, IOUT=30mA, tr=tf=5µs, Ta=25°C)

RP171x12xx



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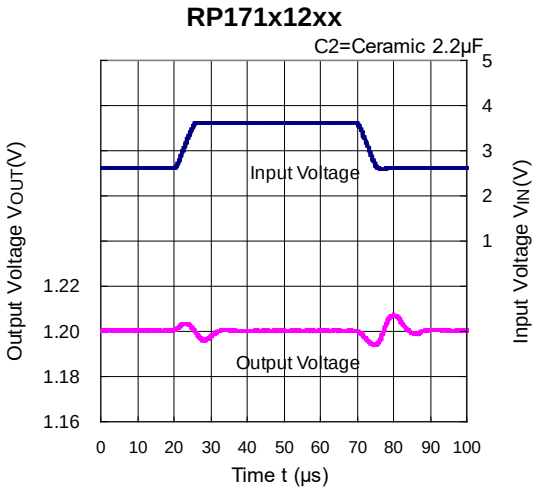

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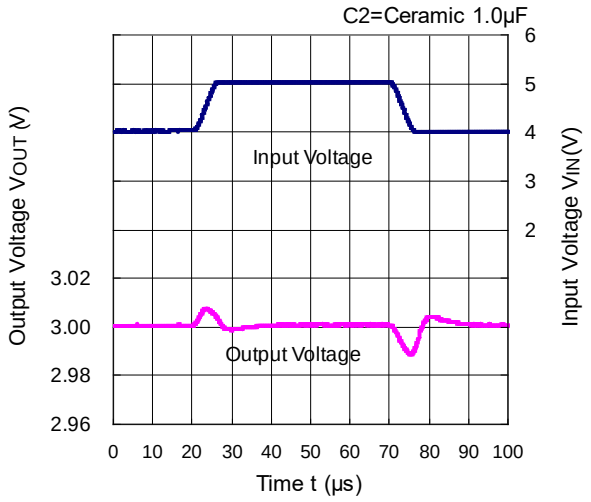

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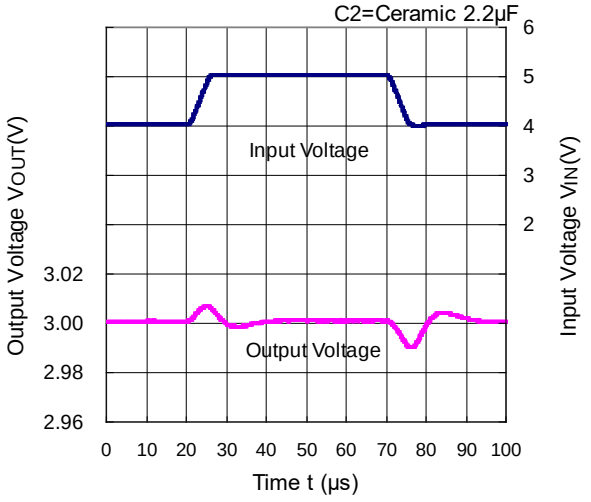
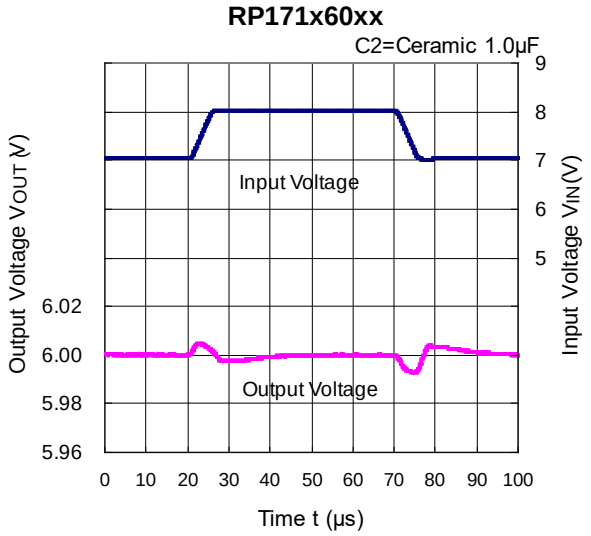
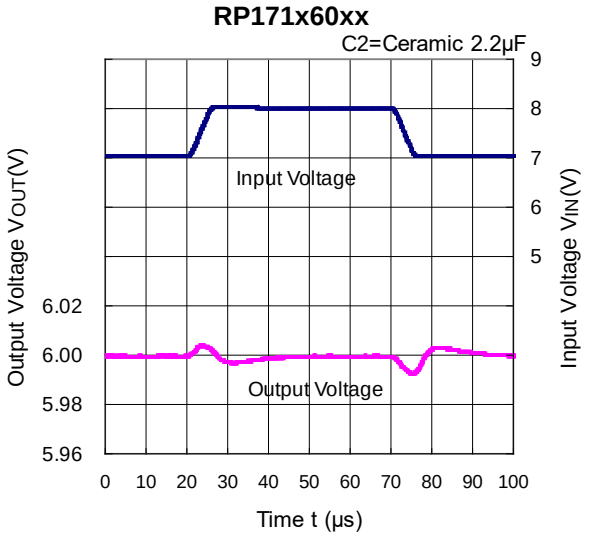


RP171x60xx

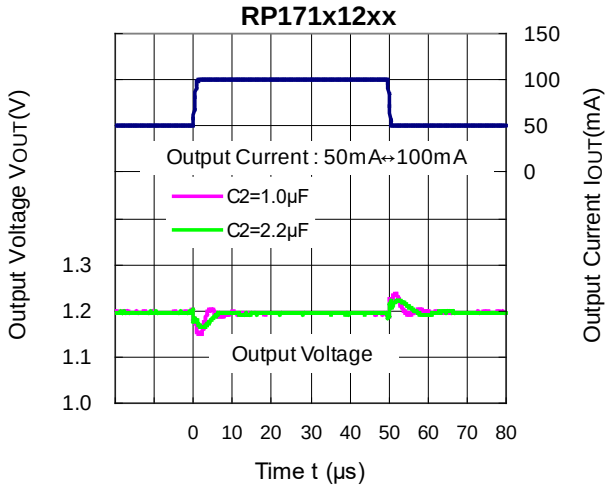


RP171x60xx

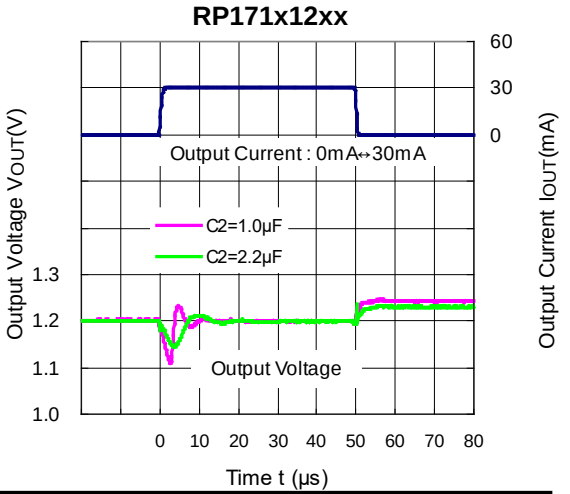


13) Load Transient Response (C1=Ceramic 1.0µF, tr=tf=500ns, Ta=25°C)

RP171x12xx



RP171x12xx



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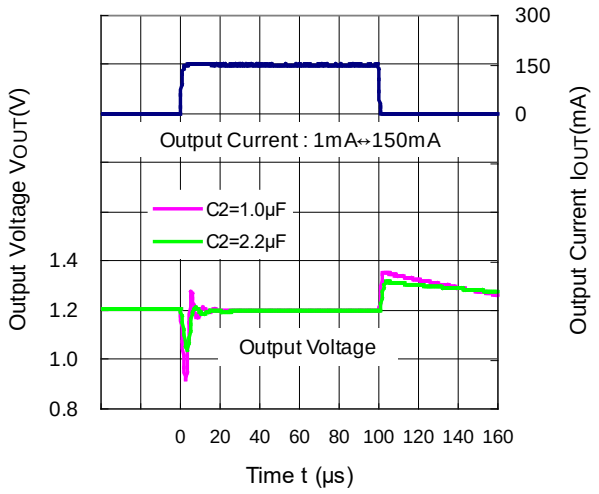

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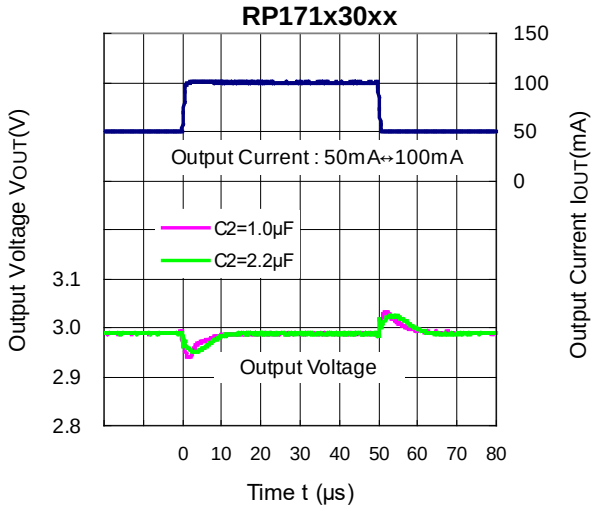

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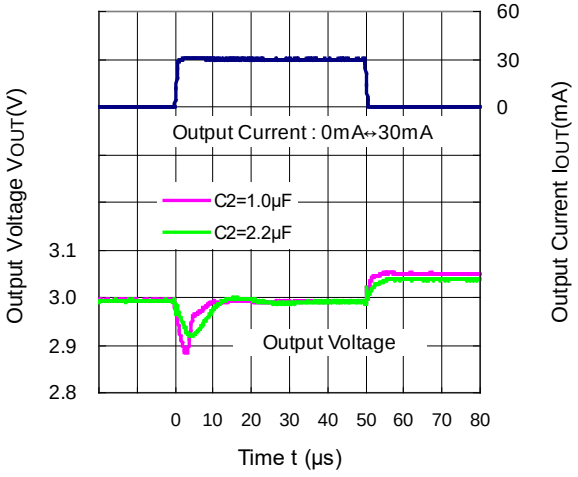

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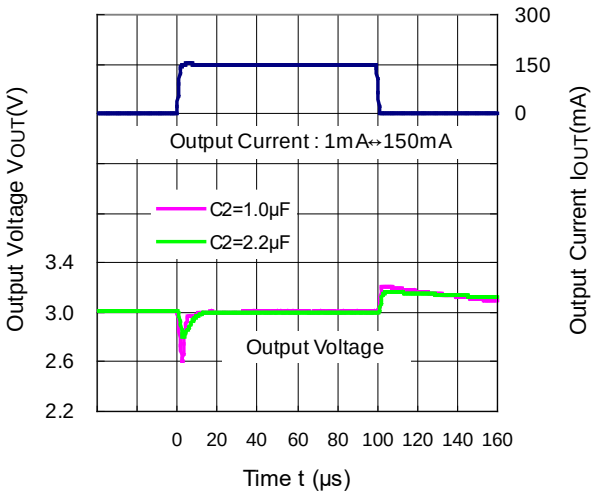

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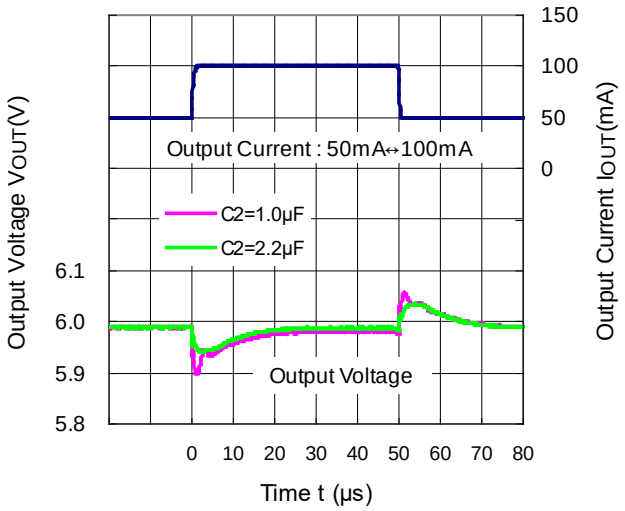

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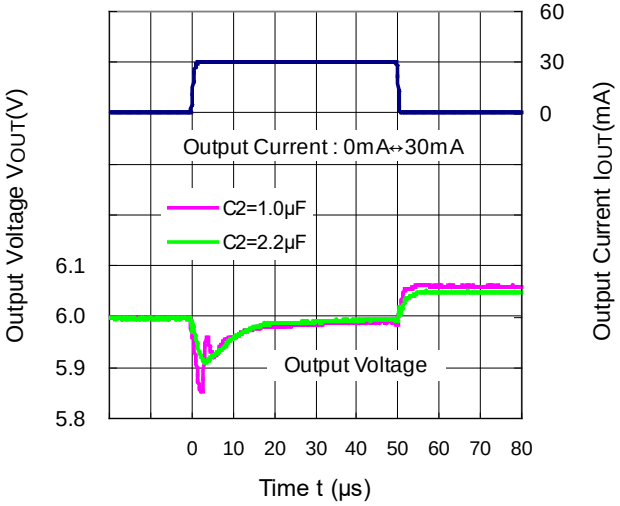

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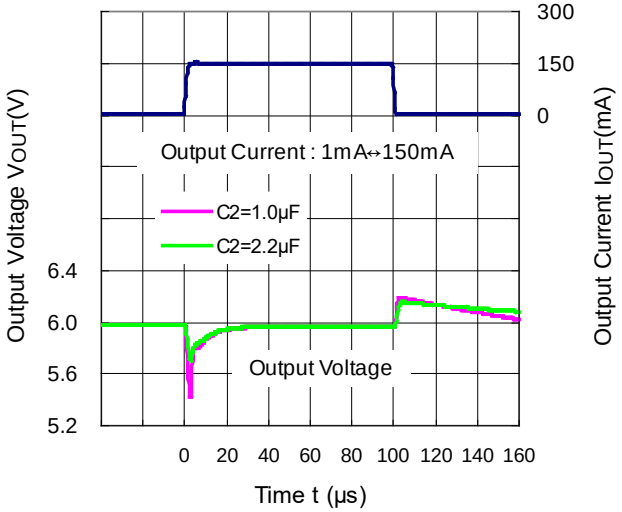
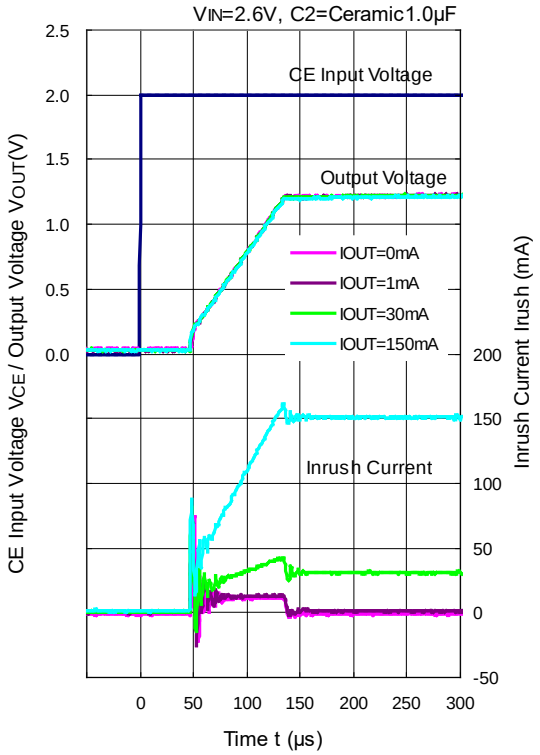


14) Turn On Speed with CE pin (C1=Ceramic 1.0µF, Ta=25°C)

RP171x12xx



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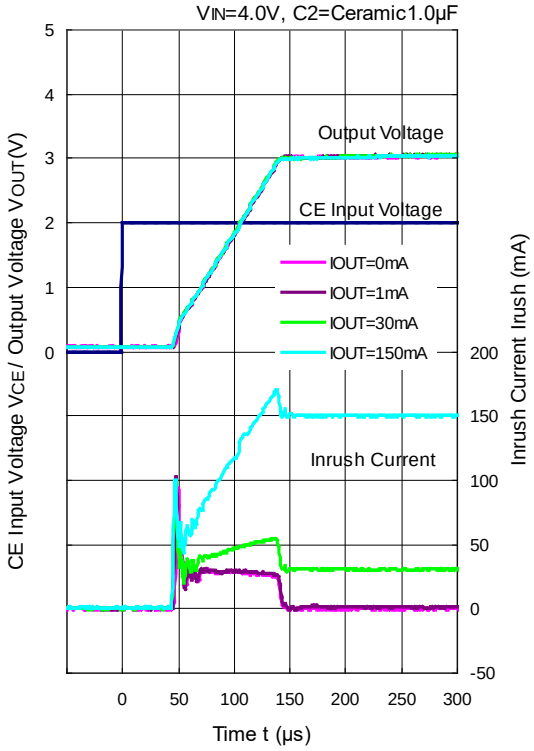
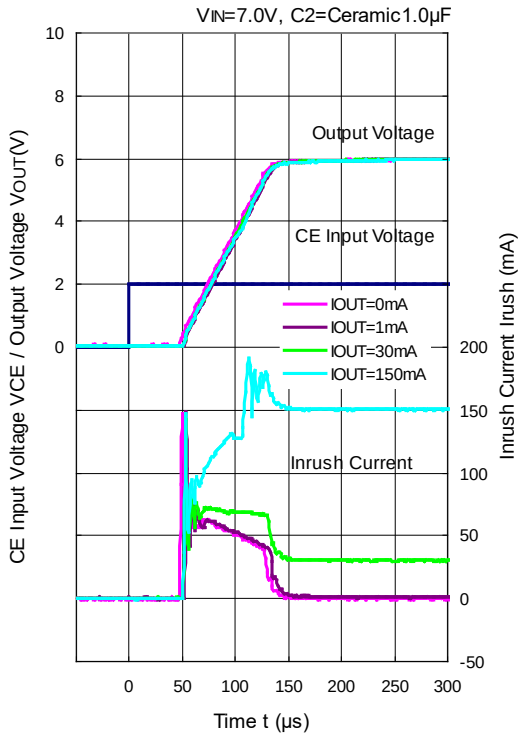


RP171x60xx



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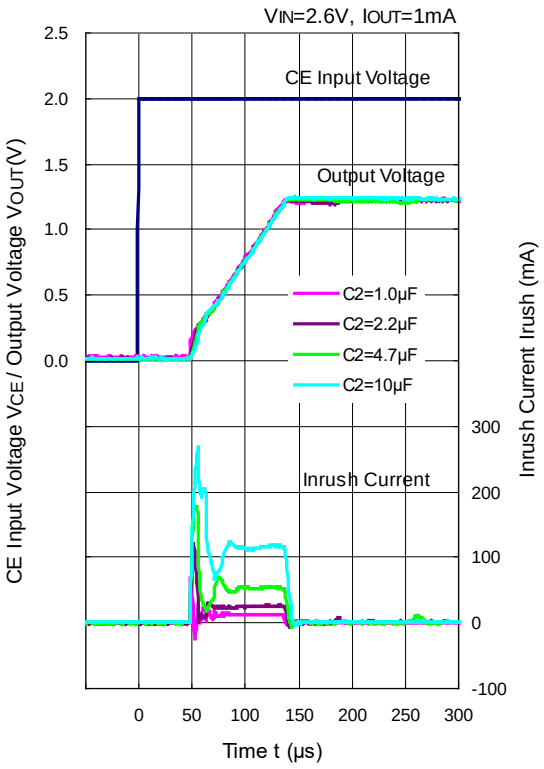
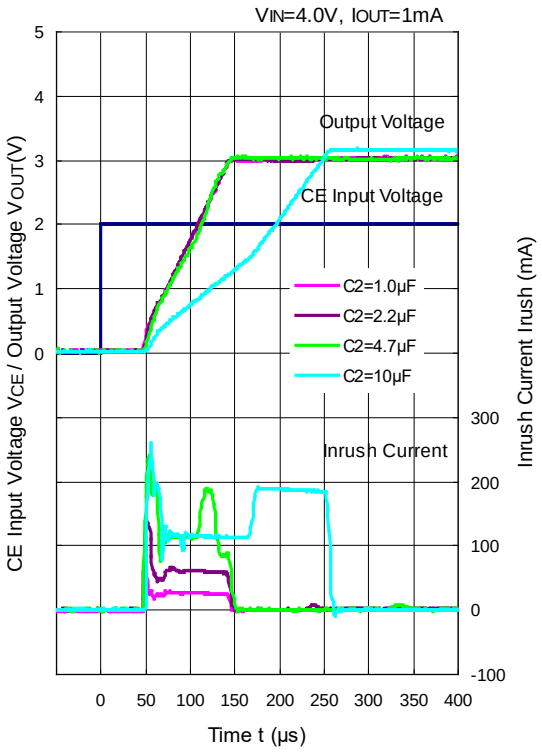
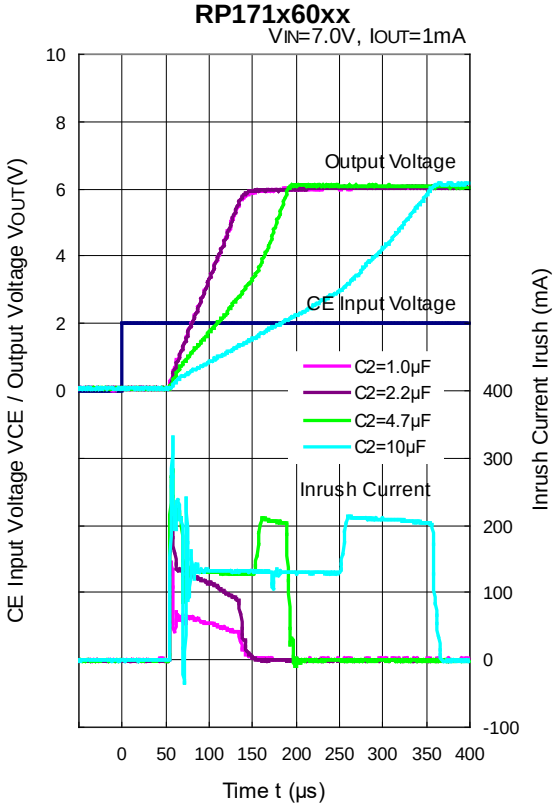


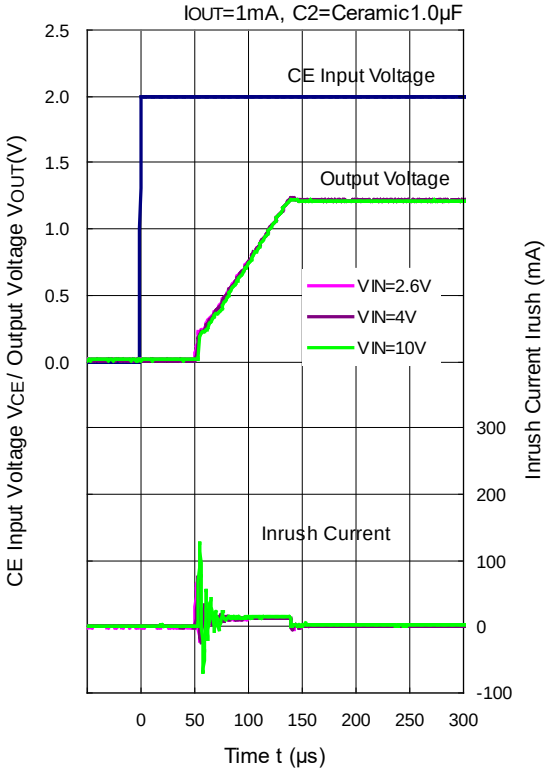
RP171x30xx



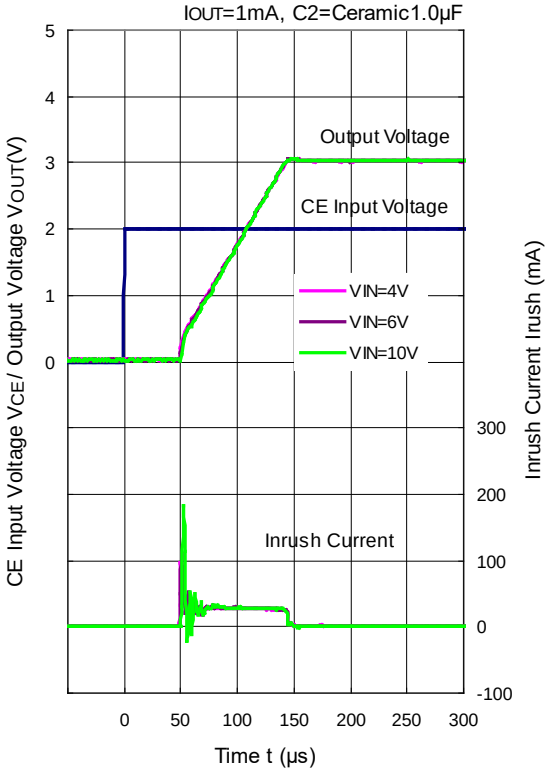
RP171x60xx



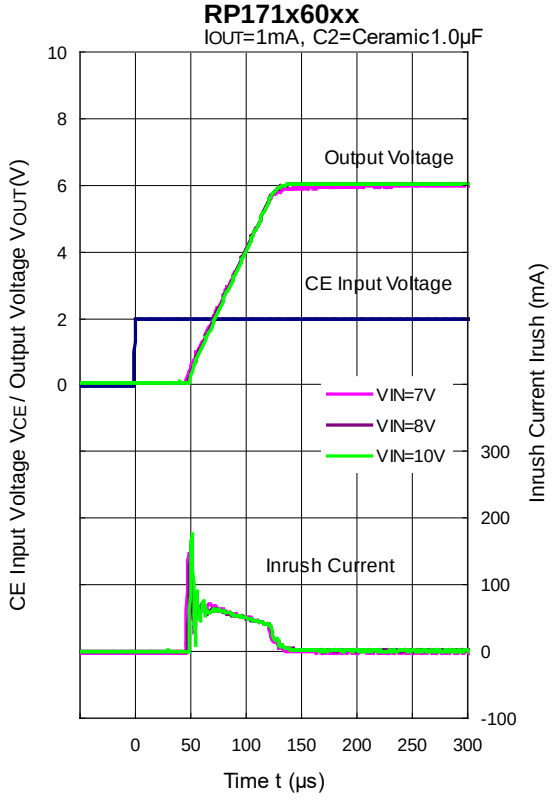
RP171x12xx



RP171x30xx

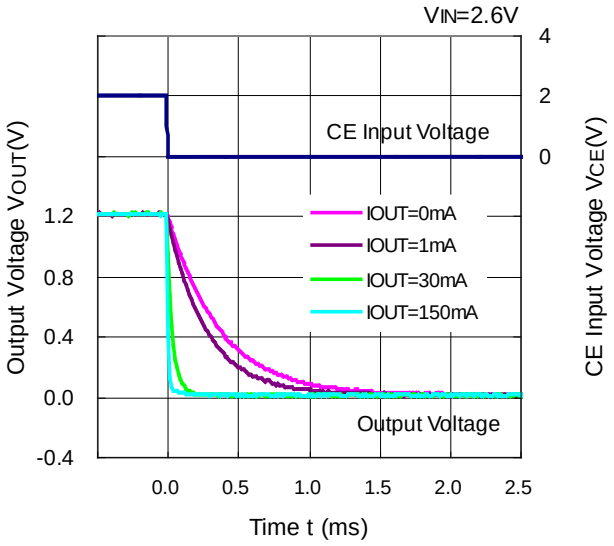


RP171x60xx

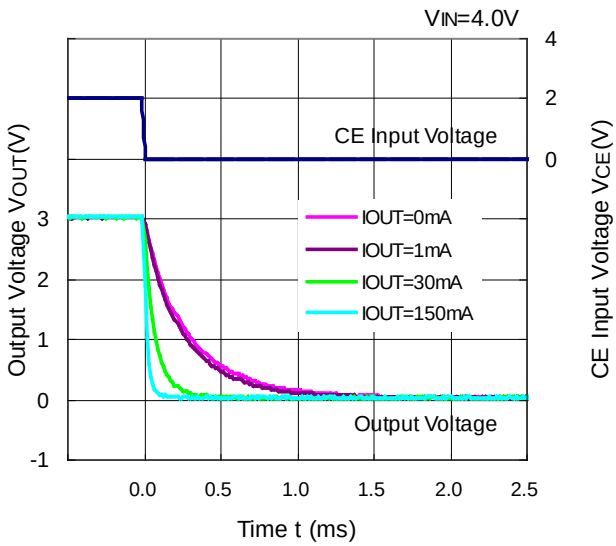


15) Turn Off Speed with CE pin (D Version) (C1=Ceramic 1.0μF, Ta=25°C)

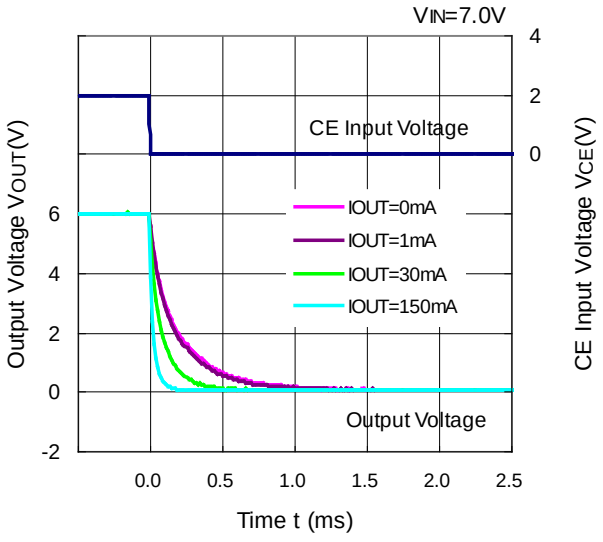
RP171x121D



RP171x301D



RP171x601D



Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

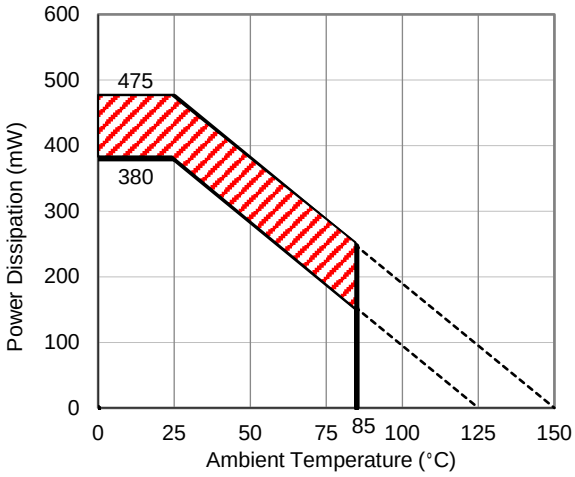
Item	Standard Test Land Pattern
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Double-Sided Board)
Board Dimensions	40 mm × 40 mm × 1.6 mm
Copper Ratio	Top Side: Approx. 50% Bottom Side: Approx. 50%
Through-holes	ϕ 0.5 mm × 44 pcs

Measurement Result (Ta = 25°C, Tjmax = 125°C)

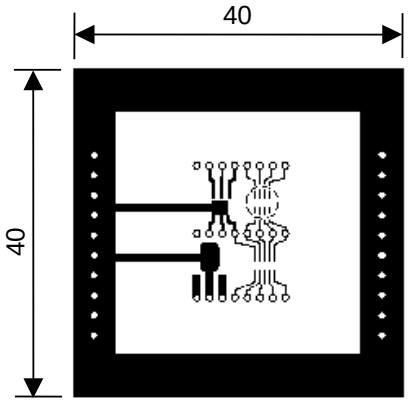
Item	Standard Test Land Pattern
Power Dissipation	380 mW
Thermal Resistance (θja)	θja = 263°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 75°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



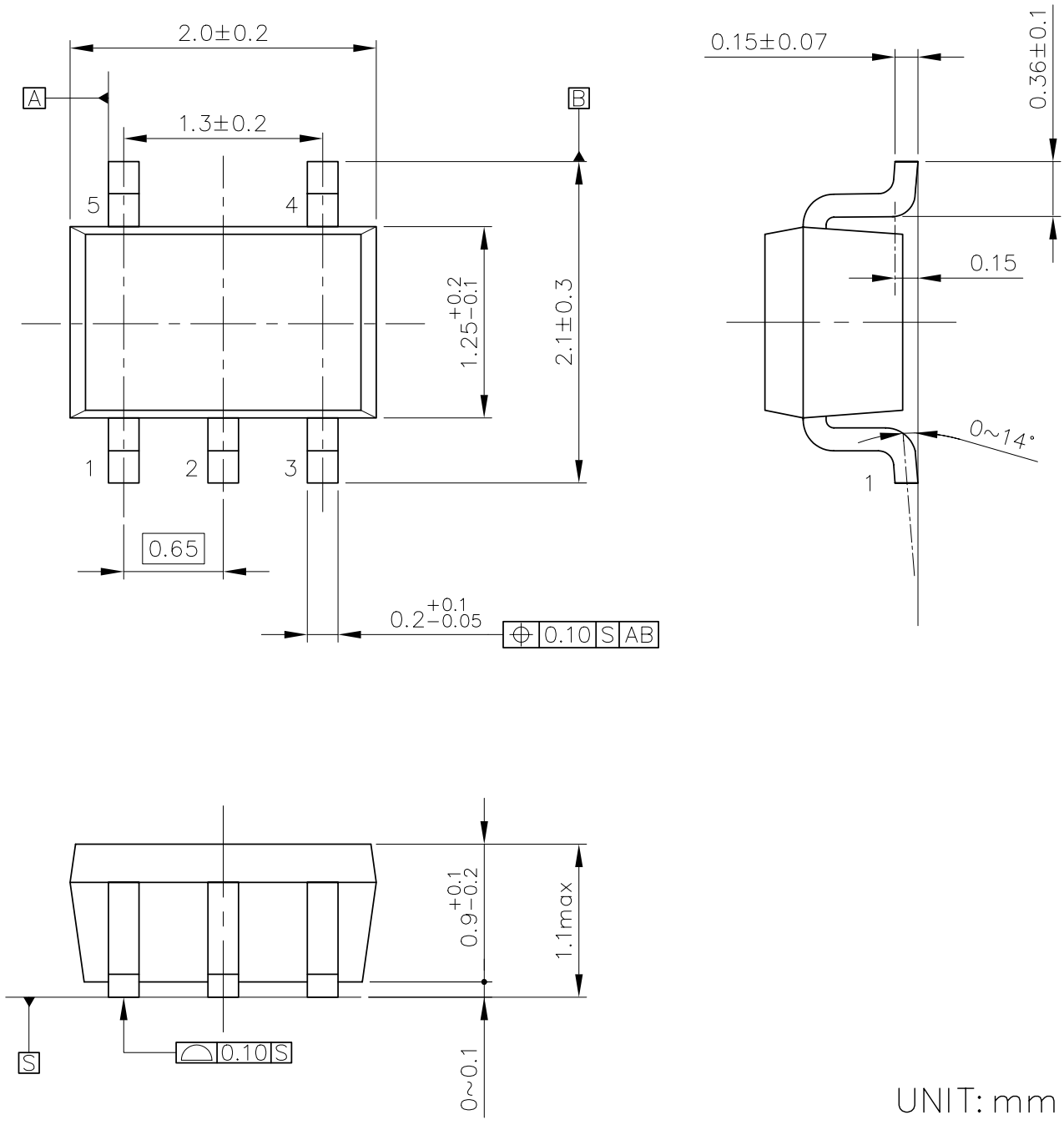
Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years



UNIT: mm

SC-88A Package Dimensions

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

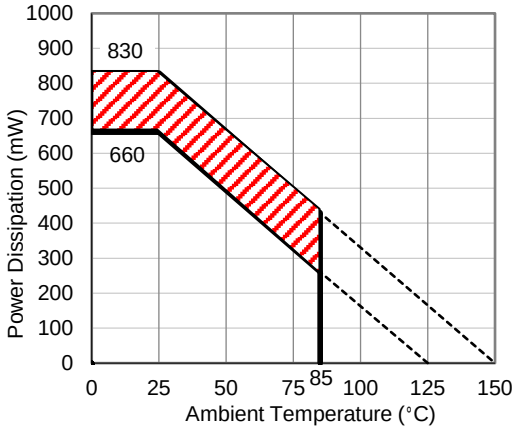
Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	ϕ 0.3 mm × 7 pcs

Measurement Result (Ta = 25°C, Tjmax = 125°C)

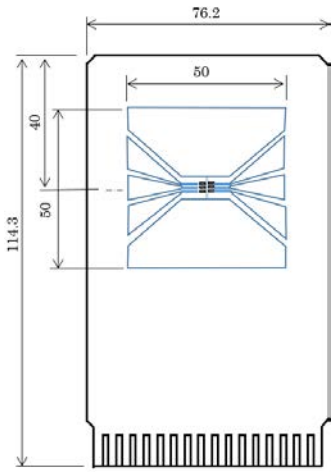
Item	Measurement Result
Power Dissipation	660 mW
Thermal Resistance (θja)	θja = 150°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



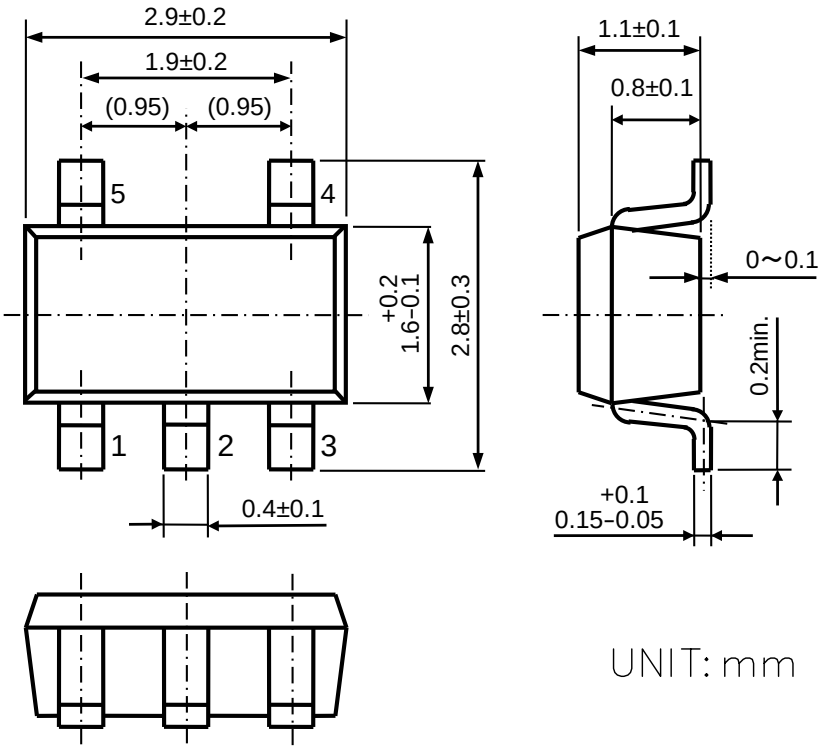
Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years



SOT-23-5 Package Dimensions

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6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. Anti-radiation design is not implemented in the products described in this document.
8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.

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Nisshinbo Micro Devices Inc.

Official website
https://www.nisshinbo-microdevices.co.jp/en/
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Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

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Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

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Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.